



NCE N&P-Channel V Complementary MOSFET

Description

The NCE30D2519K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

N channel

V_{DS} =30V,I_D =25A

 $R_{DS(ON)}$ <12m Ω @ V_{GS} =10V

 $R_{DS(ON)}$ <18m Ω @ V_{GS} =4.5V

p channel

● V_{DS} =-30V,I_D =-19A

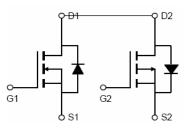
 $R_{DS(ON)}$ <35m Ω @ V_{GS} =-10V

 $R_{DS(ON)}$ <65m Ω @ V_{GS} =-4.5V

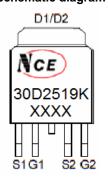
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- H-bridge
- Inverters



Schematic diagram



Marking and pin assignment

100% UIS TESTED!

100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
30D2519K	NCE30D2519K	TO-252-4L	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

	0 						
Param	Symbol	N-Channel	P-Channel	Unit			
Drain-Source Voltage		V_{DS}	30	-30	V		
Gate-Source Voltage		V _{GS}	±20	±20	V		
Continuous Dunin Current	T _C =25℃		25	-19	^		
Continuous Drain Current	T _C =100℃	I _D	17.7	-13.4	Α		
Pulsed Drain Current (Note 1)		I _{DM}	90	-60	Α		
Maximum Power Dissipation	T _C =25°C	P _D	21		W		
Operating Junction and Storage Temperature Range		T_{J} , T_{STG}	-55 To 175		$^{\circ}$		

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	7	°C/W



N-Channel Electrical Characteristics (T_C=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0	2.0	3.0	V
Desir Source On State Resistance	Б	V _{GS} =10V, I _D =7A	-	8.5	12	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =6A	-	11.8	18	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =7A	-	29	-	S
Dynamic Characteristics (Note4)			•	•		
Input Capacitance	C _{lss}	\/ -45\/\/ -0\/	-	450	-	PF
Output Capacitance	Coss	V_{DS} =15V, V_{GS} =0V, F=1.0MHz	-	150	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVITIZ	-	90	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	t _r	V_{DD} =15V , R_L =2.5 Ω	-	12	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	19	-	nS
Turn-Off Fall Time	t _f		-	6	-	nS
Total Gate Charge	Q_g	\/ -4F\/ -CA	-	9.5		nC
Gate-Source Charge	Q_{gs}	V_{DS} =15V, I_{D} =6A, V_{GS} =10V	-	2.0		nC
Gate-Drain Charge	Q_{gd}	v _{GS} -10v	-	1.9		nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =25A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	25	Α

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition:Tj=25 $^{\circ}\text{C}$,VDD=30V,VG=10V,L=0.5mH,Rg=25 Ω

N-Channel Typical Electrical and Thermal Characteristics (Curves)

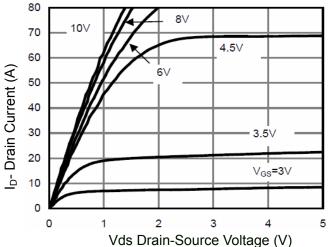


Figure 1 Output Characteristics

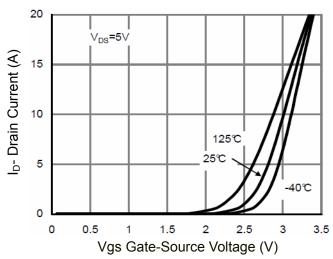


Figure 2 Transfer Characteristics

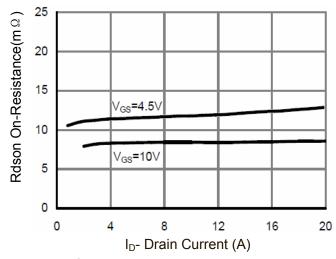


Figure 3 Rdson- Drain Current

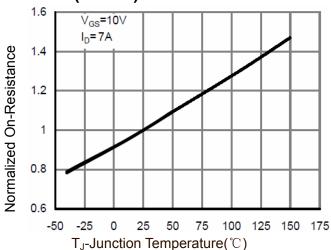


Figure 4 Rdson-Junction Temperature

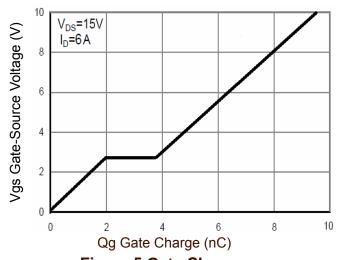


Figure 5 Gate Charge

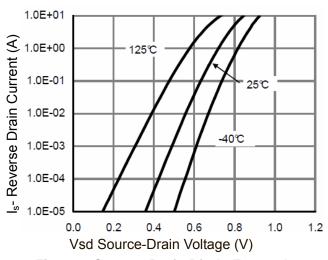
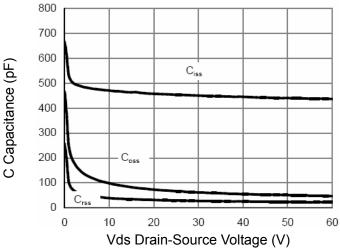


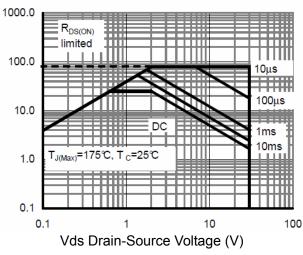
Figure 6 Source- Drain Diode Forward



30 25 Power Dissipation (W) 20 15 10 5 0 25 50 75 100 125 150 175 T_J-Junction Temperature(°C)

Figure 7 Capacitance vs Vds

Figure 9 Figure 9 Power De-rating



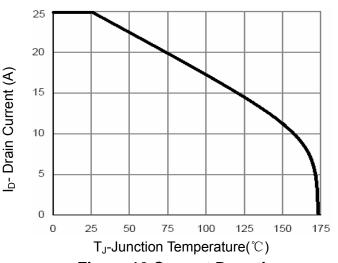
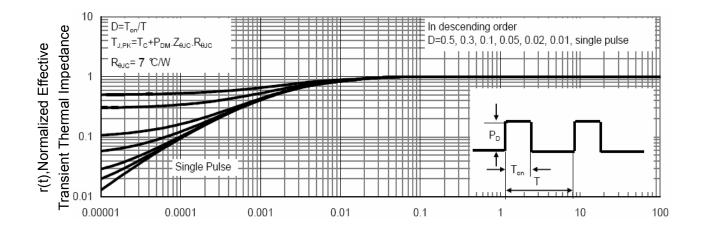


Figure 8 Safe Operation Area

Figure 10 Current De-rating



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



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P-Channel Electrical Characteristics (Tc=25 $^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-30	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS} =0V	-	-	-1	μΑ	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)			•			•	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-1.0	-1.8	-2.5	V	
Drain-Source On-State Resistance	В	V _{GS} =-10V, I _D =-6A	-	28	35	0	
Diain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-5A		48	65	mΩ	
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-6A	-	15	-	S	
Dynamic Characteristics (Note4)	·						
Input Capacitance	C _{lss}	\/ 20\/\/ 0\/	-	920	-	PF	
Output Capacitance	C _{oss}	V_{DS} =-30V, V_{GS} =0V, F=1.0MHz	-	140	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.UIVITZ	-	90	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	8	-	nS	
Turn-on Rise Time	t _r	V_{DD} =-15V , R_L =2.5 Ω	-	30	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{G} =3 Ω	-	22	-	nS	
Turn-Off Fall Time	t _f		-	26	-	nS	
Total Gate Charge	Qg	\/ - 45\/ \ - CA	-	16.2		nC	
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-6A, V _{GS} =-10V	-	2.9		nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	3.6		nC	
Drain-Source Diode Characteristics	- '		•			•	
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS} =0 V , I_{S} =-6 A	-		-1.2	V	
Diode Forward Current (Note 2)	Is		-	-	-19	Α	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-6A	-	23	-	nS	
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	14	-	nC	





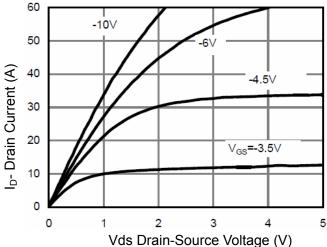


Figure 1 Output Characteristics

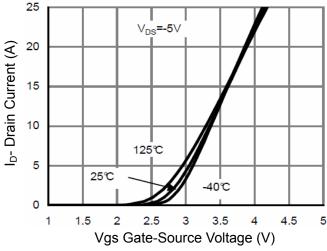


Figure 2 Transfer Characteristics

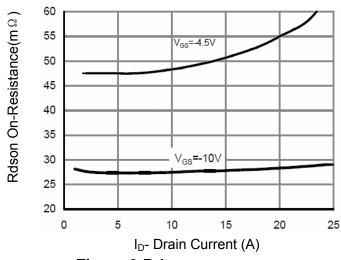


Figure 3 Rdson- Drain Current

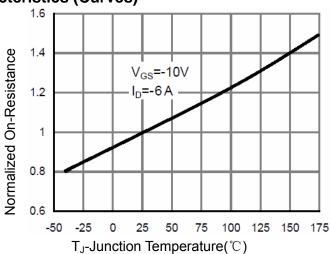


Figure 4 Rdson-Junction Temperature

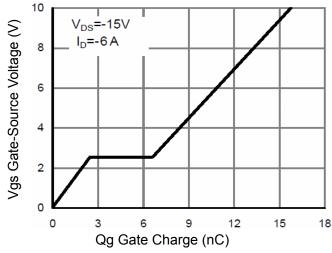


Figure 5 Gate Charge

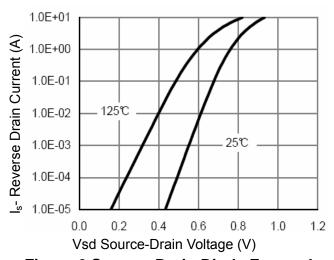
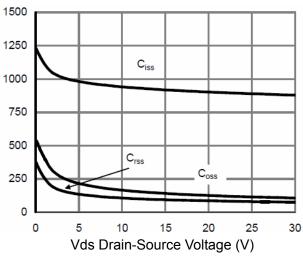


Figure 6 Source- Drain Diode Forward



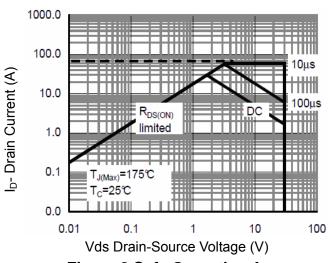
Power Dissipation (W) 20 15 10 5 0 0 25 50 75 100 125 150 175

30

25

Figure 7 Capacitance vs Vds

 T_J -Junction Temperature($^{\circ}$ C) Figure 9 Power De-rating



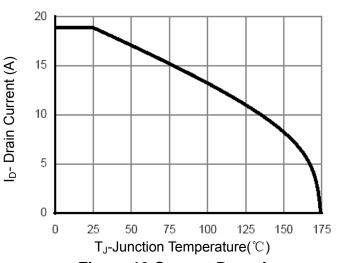
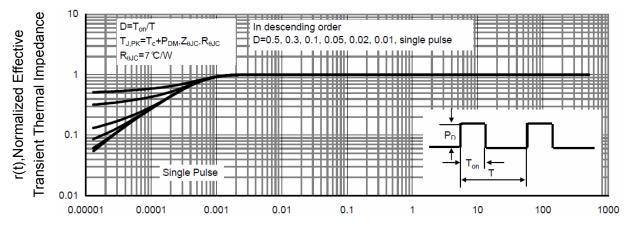


Figure 8 Safe Operation Area

Figure 10 Current De-rating



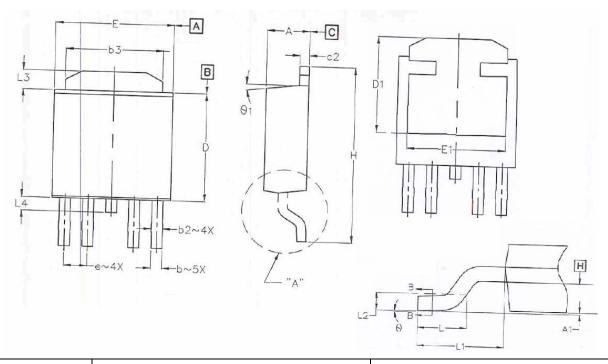
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252-4L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.184	2.387	0.086	0.094	
A1	-	0.127	-	0.094	
b	0.508	0.711	0.020	0.028	
b1	0.508	0.660	0.020	0.026	
b2	0.610	0.787	0.024	0.031	
b3	4.953	5.461	0.195	0.215	
С	0.460	0.610	0.018	0.024	
c1	0.410	0.559	0.016	0.022	
C2	0.460	12.950	0.498	0.510	
D	4.980	5.180	0.196	0.204	
D1	2.650	2.950	0.104	0.116	
E	7.900	8.100	0.311	0.319	
E1	0.000	0.300	0.000	0.012	
е	12.900	13.400	0.508	0.528	
Н	2.850	3.250	0.112	0.128	
L	1.397	1.778	0.055	0.070	
L1	2.743	BSC	0.108	BSC	
L2	0.508	BSC	0.020	BSC	
L3	0.889	1.270	0.035	0.050	
L4	-	1.015	-	0.040	
θ	0.	10°	0.	10°	
θ 1	0.	15°	0.	15°	



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